

# FMP20N50ES

**FUJI POWER MOSFET** 

# Super FAP-E<sup>3S</sup> series

# **N-CHANNEL SILICON POWER MOSFET**

#### ■ Features

Maintains both low power loss and low noise Lower  $R_{DS}(on)$  characteristic More controllable switching dv/dt by gate resistance Smaller  $V_{GS}$  ringing waveform during switching Narrow band of the gate threshold voltage (4.2±0.5V) High avalanche durability

## Applications

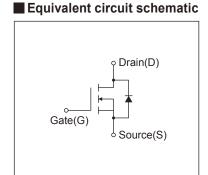
Switching regulators UPS (Uninterruptible Power Supply) DC-DC converters

# ■ Maximum Ratings and Characteristics

# ● Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

| TO-220AB 10 43 10 10 10 10 10 10 10 10 10 10 10 10 10 | 4,5 10.2   |
|---|--|
| Trodemark  Type name  Lot No.                         | 15.80.2  |
| 1,2:0,2   | PRE-SOLDER   |
| 2,54 ±0.2 2,54 ±0.2                                   | 0.4 % 2<br>2.7 ±0.2<br>WENSIONS ARE IN MILLIMETERS |
| + + +<br>① ② ③  | ONNECTION ① GATE ② DRAIN ③ SOURCE                  |

■ Outline Drawings [mm]



| Description   | Symbol           | Characteristics | Unit  | Remarks                |
|---|------------------|-----------------|-------|------------------------|
| Drain Sauras Valtara                                    | V <sub>DS</sub>  | 500             | V     |                        |
| Drain-Source Voltage                                    | V <sub>DSX</sub> | 500             | V     | V <sub>GS</sub> = -30V |
| Continuous Drain Current                                | I <sub>D</sub>   | ±20             | А     |                        |
| Pulsed Drain Current                                    | IDP              | ±80             | Α     |                        |
| Gate-Source Voltage                                     | V <sub>GS</sub>  | ±30             | V     |                        |
| Repetitive and Non-Repetitive Maximum Avalanche Current | Iar              | 20              | А     | Note*1                 |
| Non-Repetitive Maximum Avalanche Energy                 | Eas              | 582.5           | mJ    | Note*2                 |
| Repetitive Maximum Avalanche Energy                     | Ear              | 27              | mJ    | Note*3                 |
| Peak Diode Recovery dV/dt                               | dV/dt            | 4.6             | kV/μs | Note*4                 |
| Peak Diode Recovery -di/dt                              | -di/dt           | 100             | A/µs  | Note*5                 |
| Martin and Programme Control                            | PD               | 2.02            | 14/   | Ta=25°C                |
| Maximum Power Dissipation                               |                  | 270             | W     | Tc=25°C                |
| O   | Tch              | 150             | °C    |                        |
| Operating and Storage Temperature range                 | Teta             | -55 to + 150    | °C.   |                        |

### ● Electrical Characteristics at Tc=25°C (unless otherwise specified)

| Description                      | Symbol               | Conditions   |  | min. | typ. | max.  | Unit |  |
|----------------------------------|----------------------|--|--|------|------|-------|------|--|
| Drain-Source Breakdown Voltage   | BV <sub>DSS</sub>    | I <sub>D</sub> =250µA, V <sub>GS</sub> =0V                           |  | 500  | -    | -     | V    |  |
| Gate Threshold Voltage           | V <sub>GS</sub> (th) | I <sub>D</sub> =250µA, V <sub>DS</sub> =V <sub>GS</sub>              |  | 3.7  | 4.2  | 4.7   | V    |  |
| Zero Gate Voltage Drain Current  | IDSS                 | V <sub>DS</sub> =500V, V <sub>GS</sub> =0V                           | T <sub>ch</sub> =25°C                      | -    | -    | 25    |      |  |
|                                  |                      | V <sub>DS</sub> =400V, V <sub>GS</sub> =0V                           | T <sub>ch</sub> =125°C                     | -    | -    | 250   | μA   |  |
| Gate-Source Leakage Current      | Igss                 | V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V                           | V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V |      | 10   | 100   | nA   |  |
| Drain-Source On-State Resistance | Ros (on)             | I <sub>D</sub> =10A, V <sub>GS</sub> =10V                            |  | -    | 0.27 | 0.31  | Ω    |  |
| Forward Transconductance         | g <sub>fs</sub>      | I <sub>D</sub> =10A, V <sub>DS</sub> =25V                            |  | 5    | 10   | -     | S    |  |
| nput Capacitance                 | Ciss                 | V <sub>0S</sub> =25V<br>V <sub>GS</sub> =0V<br>f=1MHz                |  | -    | 2100 | 3150  | pF   |  |
| Output Capacitance               | Coss                 |  |  | -    | 250  | 375   |      |  |
| Reverse Transfer Capacitance     | Crss                 |  |  | -    | 15   | 22.5  |      |  |
| Turn-On Time Turn-Off Time       | td(on)               | $V_{cc}$ =300V $V_{GS}$ =10V $I_{D}$ =10A $R_{GS}$ =15 $\Omega$      |  | -    | 40   | 60    | ns   |  |
|                                  | tr                   |  |  | -    | 38   | 57    |      |  |
|                                  | td(off)              |  |  | -    | 85   | 127.5 |      |  |
|                                  | tf                   |  |  | -    | 17   | 25.5  |      |  |
| Total Gate Charge                | Q <sub>G</sub>       | V <sub>cc</sub> =250V<br>I <sub>D</sub> =20A<br>V <sub>cs</sub> =10V |  | -    | 57   | 85.5  |      |  |
| Gate-Source Charge               | Q <sub>GS</sub>      |  |  | -    | 21   | 31.5  | nC   |  |
| Gate-Drain Charge                | Q <sub>GD</sub>      |  |  | -    | 21   | 31.5  |      |  |
| Gate-Drain Crossover Charge      | Qsw                  |  |  | -    | 10   | 15    |      |  |
| Avalanche Capability             | lav                  | L=1.07mH, T <sub>ch</sub> =25°C                                      |  | 20   | -    | -     | Α    |  |
| Diode Forward On-Voltage         | V <sub>SD</sub>      | I <sub>F</sub> =20A, V <sub>GS</sub> =0V, T <sub>ch</sub> =25°C      |  | -    | 0.90 | 1.35  | V    |  |
| Reverse Recovery Time            | trr                  | I <sub>F</sub> =20A, V <sub>GS</sub> =0V                             |  | -    | 0.5  | -     | μs   |  |
| Reverse Recovery Charge          | Qrr                  | -di/dt=100A/µs, Tch=25°C   |  | -    | 7.0  | -     | μC   |  |

#### Thermal Characteristics

| Description        | Symbol     | Test Conditions    | min. | typ. | max.  | Unit |
|--------------------|------------|--------------------|------|------|-------|------|
| Thermal resistance | Rth (ch-c) | Channel to Case    |      |      | 0.460 | °C/W |
|                    | Rth (ch-a) | Channel to Ambient |      |      | 62.0  | °C/W |

Note \*1 : Tch≤150°C

Note \*2 : Stating Tch=25°C, Ias=8A, L=16.7mH, Vcc=50V, Rg=50 $\Omega$ . Eas limited by maximum channel temperature and avalanche current. See to 'Avalanche Energy' graph.

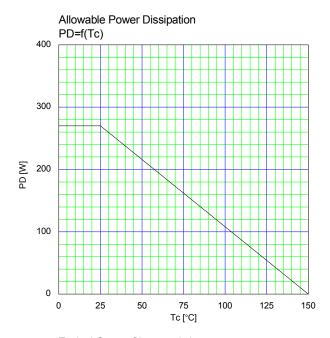
Note \*3 : Repetitive rating : Pulse width limited by maximum channel temperature.

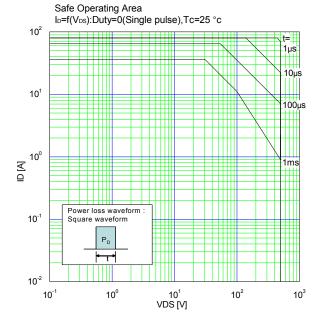
See to the 'Transient Themal impeadance' graph.

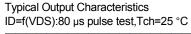
Note \*4 : Ir≤-Iɒ, -di/dt=100A/µs, Vcc≤BVɒss, Tch≤150°C.

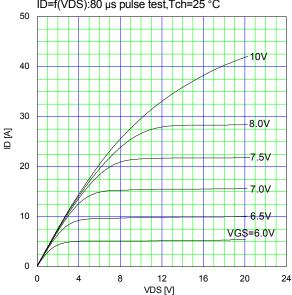
Note \*5 : Ir≤-Iɒ, dv/dt=4.6kV/µs, Vcc≤BVɒss, Tch≤150°C.

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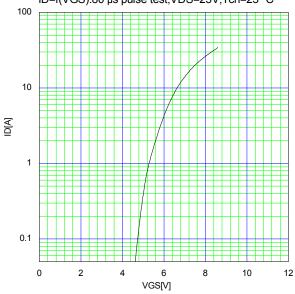




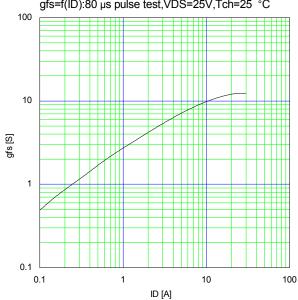




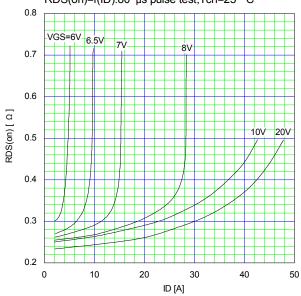
Typical Transfer Characteristic ID=f(VGS):80 µs pulse test,VDS=25V,Tch=25 °C



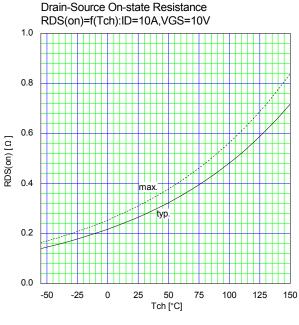
Typical Transconductance gfs=f(ID):80 µs pulse test,VDS=25V,Tch=25 °C

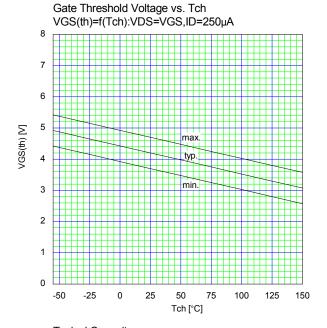


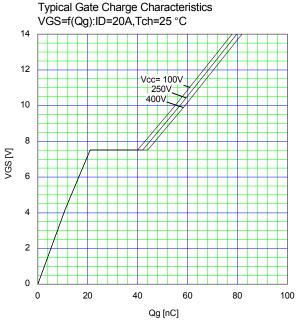
Typical Drain-Source on-state Resistance RDS(on)=f(ID):80 µs pulse test,Tch=25 °C

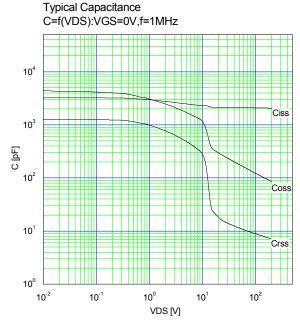


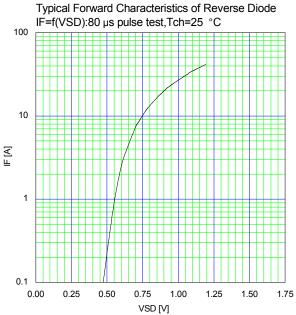
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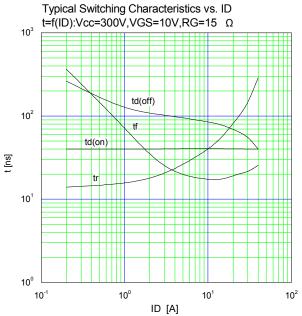


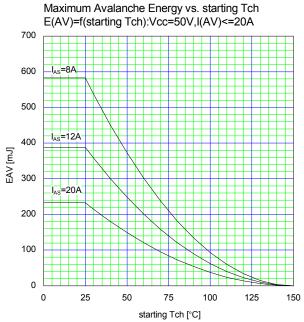


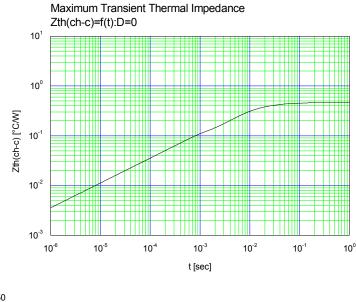












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